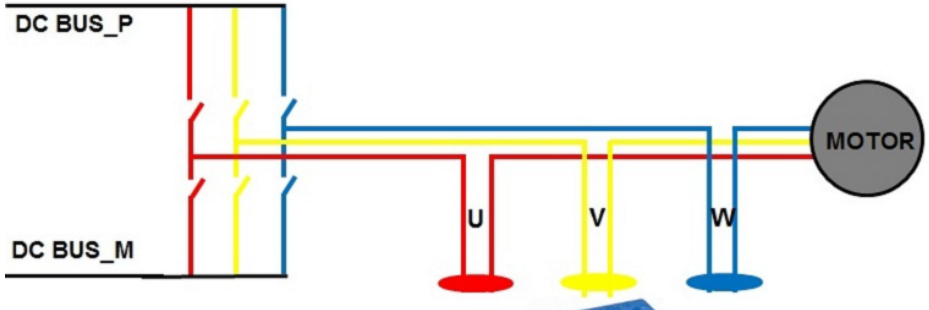
Revision History	
Revision	Notes



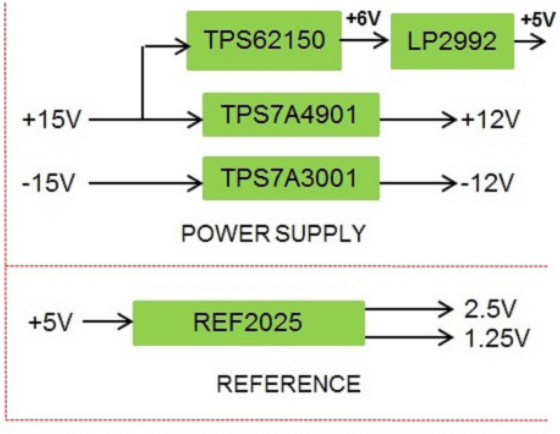
Hall Effect Current Sensor from LEM

BURDEN

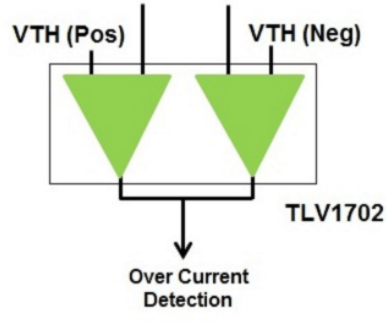
Level shifting → OPA322

Gain + Filtering → THS4531A

Note: The SMA Connectors are used to connect to external ADC EVMs



The voltage across Burden is also given as input to the comparators for OC detection.



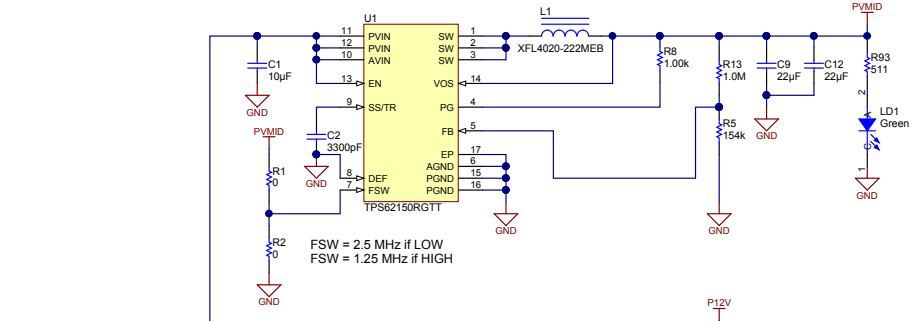
Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

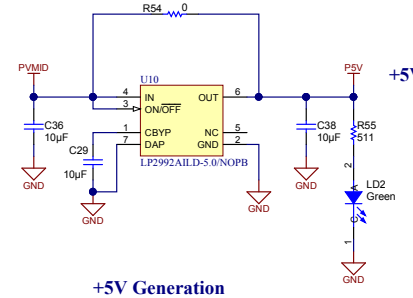
Orderable: N/A		Designed for: Public Release	Mod. Date: 6/18/2015
TID #: TIDA-00368		Project Title: Motor Current Measurement using Hall Sensors	
Number: TIDA-00368	Rev: E2	Sheet Title: Block Diagram	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 1 of 6
Drawn By: Sanjay Pithadia		File: SH01_CoverSheet.SchDoc	Size: B
Engineer: Sanjay Pithadia		Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com

© Texas Instruments 2015

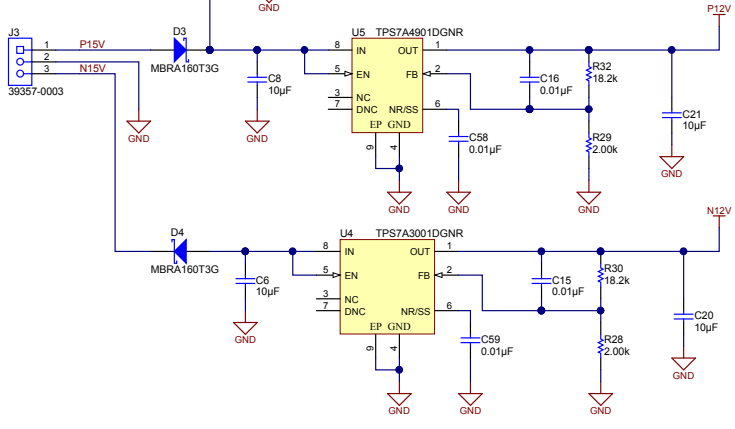
Currently PVMID is set to 6V and R54 is DNP.
When LP2992 is not used, Mount R54 and Set PVMID = 5V



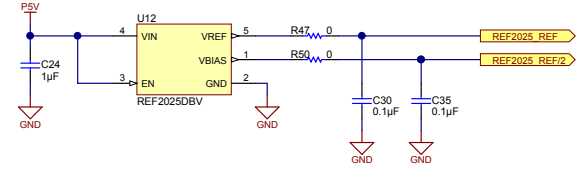


+5V OutPut

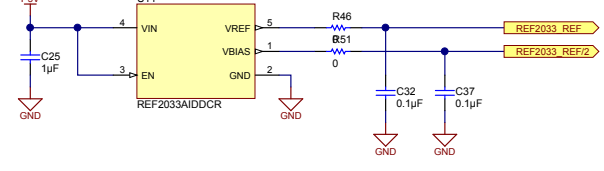
+5V Generation



+12V and -12V Generation



+2.5V Reference and +1.25V Bias supply



+3.3V Reference and +1.65V Bias supply

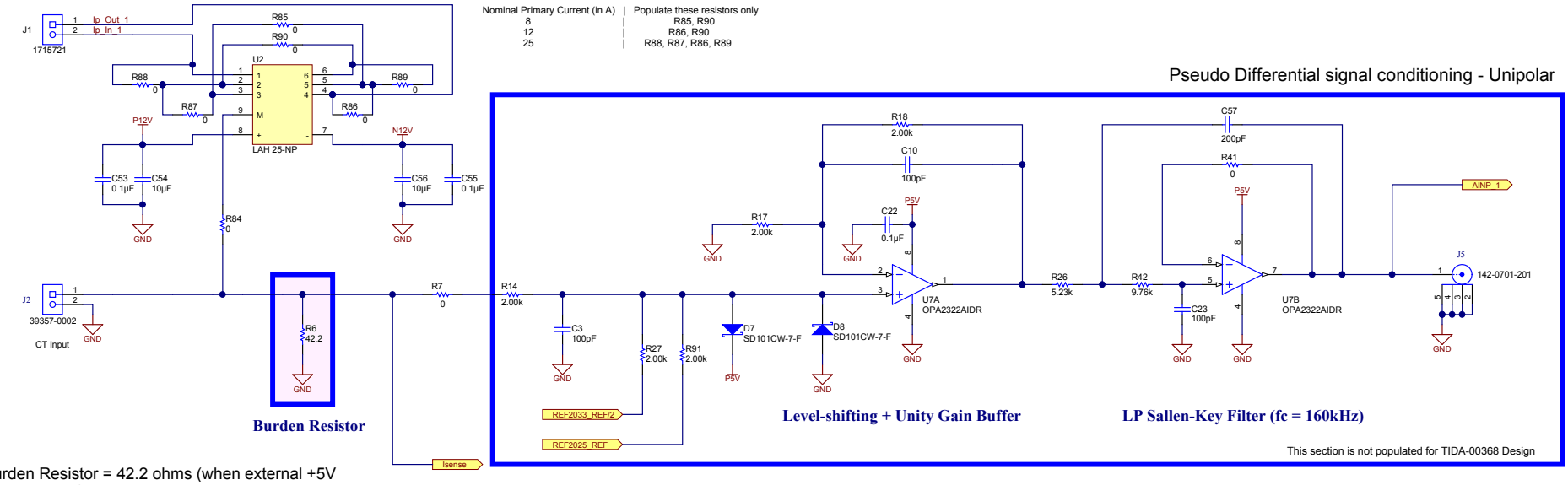
This section is not populated for TIDA-00368 Design

Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

Orderable: N/A	Designed for: Public Release	Mod. Date: 6/18/2015
TID #: TIDA-00368	Project Title: Motor Current Measurement using Hall Sensors	
Number: TIDA-00368 Rev: E2	Sheet Title: Power Supply	
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 2 of 6
Drawn By: Sanjay Pithadia	File: SH02_Power_supply.SchDoc	Size: B
Engineer: Sanjay Pithadia	Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com

© Texas Instruments 2015

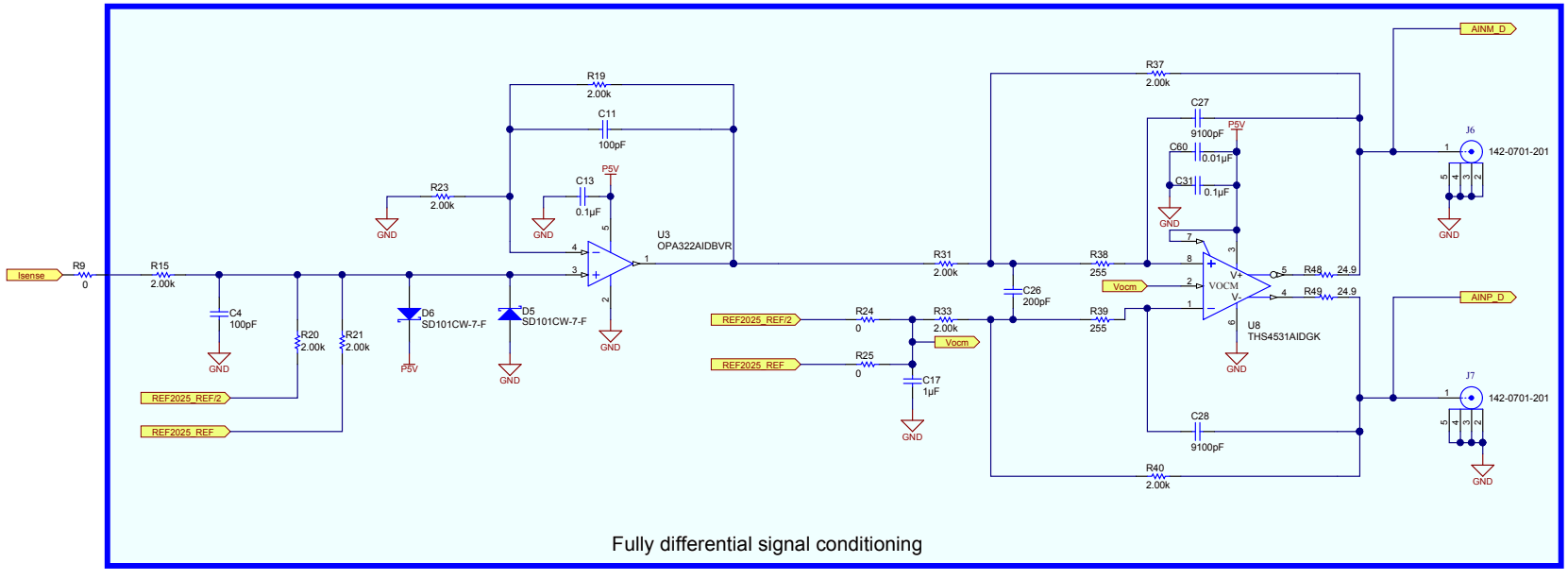


Number of primary turns	Primary current nominal I_{PN} [A]	Primary current maximum I_P [A]	Nominal output current I_{SN} [mA]	Turns ratio K_N	Primary resistance R_P [mΩ]	Primary insertion inductance L_P [µH]	Recommended PCB connections
1	25	55	25	1 : 1000	0.18	0.012	3 2 1 IN OUT 4 5 6
2	12	27	24	2 : 1000	0.81	0.054	3 2 1 IN OUT 4 5 6
3	8	18	24	3 : 1000	1.62	0.110	3 2 1 IN OUT 4 5 6

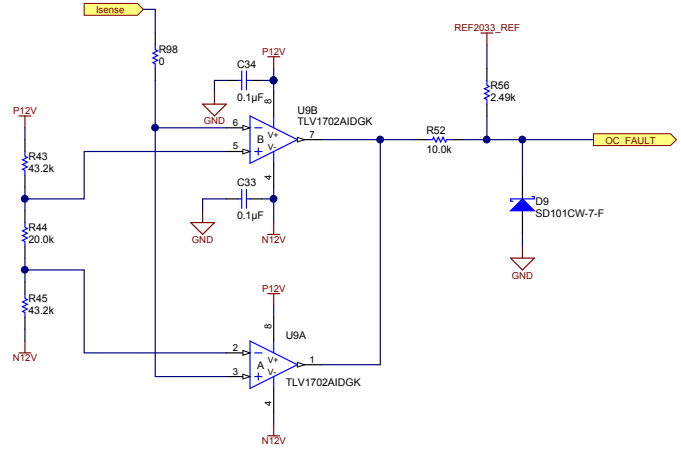
Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

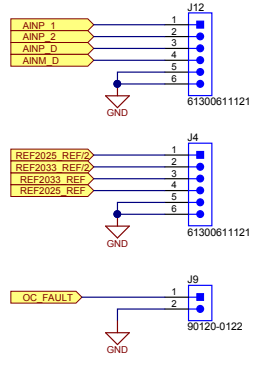
Orderable: N/A	Designed for: Public Release	Mod. Date: 6/18/2015
TID #: TIDA-00368	Project Title: Motor Current Measurement using Hall Sensors	
Number: TIDA-00368 Rev: E2	Sheet Title: Signal Chain - Pseudo Differential	
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 3 of 6
Drawn By: Sanjay Pithadia	File: SH03_Single_ended_SC_to_ADC.SchDoc	Size: B
Engineer: Sanjay Pithadia	Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com
© Texas Instruments 2015



Fully differential signal conditioning





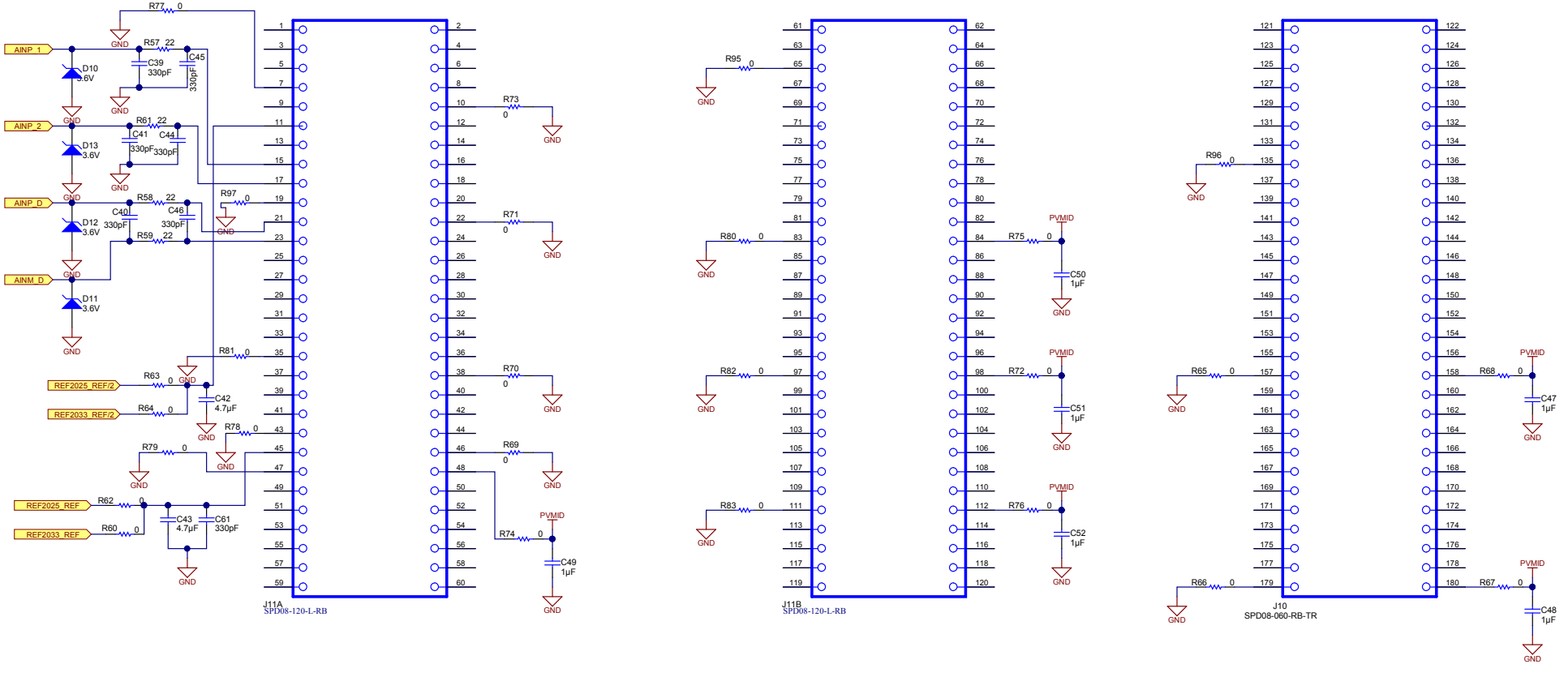
Overcurrent Protection

Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

Orderable: N/A	Designed for: Public Release	Mod. Date: 6/18/2015
TID #: TIDA-00368	Project Title: Motor Current Measurement using Hall Sensors	
Number: TIDA-00368 Rev: E2	Sheet Title: Signal Chain - Fully Differential + ADS7854	
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 4 of 6
Drawn By: Sanjay Pithadia	File: SH04_Fully_differential_ended_SC_to_ADC.SchDoc	Size: B
Engineer: Sanjay Pithadia	Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com

© Texas Instruments 2015



Connection to Delfino Control Card

Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

Number: TIDA-00368	Rev: E2	Designed for: Public Release	Mod. Date: 6/18/2015
SVN Rev: Not in version control		Project Title: Motor Current Measurement using Hall Sensors	
Drawn By: Sanjay Pithadia		Sheet Title: Delfino Controller Interface	
Engineer: Sanjay Pithadia		Assembly Variant: Variant name not interpreted	Sheet: 5 of 6
		File: SH05_180_pin_connector_interface.SchDoc	Size: B
		Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com

© Texas Instruments 2015

H2
NY PMS 440 0025 PH

H1
NY PMS 440 0025 PH

H3
NY PMS 440 0025 PH

H4
NY PMS 440 0025 PH

H12
1902C

H11
1902C

H9
1902C

H10
1902C

FID2 FID1 FID3 FID6 FID5 FID4

PCB Number: TIDA-00368
PCB Rev: E2

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

Orderable: N/A	Designed for: Public Release	Mod. Date: 6/18/2015
TID #: TIDA-00368	Project Title: Motor Current Measurement using Hall Sensors	
Number: TIDA-00368 Rev: E2	Sheet Title:	
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 6 of 6
Drawn By:	File: SH06_Hardware.SchDoc	Size: B
Engineer: Sanjay Pithadia	Contact: http://www.ti.com/support	

Texas Instruments
http://www.ti.com

© Texas Instruments 2015

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers (“Buyers”) who are developing systems that incorporate TI semiconductor products (also referred to herein as “components”). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer’s systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER’S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI’s terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI’s terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer’s safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have ***not*** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2015, Texas Instruments Incorporated